









Tm 110













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P2F - Push to Fix - Fixing element for PCBs 28.901.U164.10

DESCRIPTION

Quick assembly process improves production efficiency and reduces production costs

Push-in fixing: for hole pattern in light fitting ø 4.2 +/- 0.1 mm and ø 4.3-4,8 mm in PCBs

Reliable heat dissipation by permanent, constant contact pressure with a minimum pressure force of 5 N

CrNi and silicone materials ensure long life reliability

Suitable for Zhaga certified LED modules

BJB recommends to use modules with ø 4,3-4,8 mm fixing hole diameter

Due to manufacturing tolerances and tolerances required for thermal expansion, we recommend choosing the largest possible hole diameter Eliminates potential damage from screw fixing due to low insertion force

Assembly without any additional tools possible

Solutions for Automation upon request

Removable from front

| Product name: | P2F - Push to Fix - Fixing element for PCBs |
|----------------------|---|
| Country of origin: | DE |
| Packaging type: | Bag |
| Packaging quantity: | 5000.000 |
| Mounting method 1: | Push-in fixing for mounting PCBs |
| Total thickness (X): | 2.4 - 2.7 mm |
| Material: | CrNi with silicone insulating ring |
| Color: | gray |
| Weight: | 2 |
| Pkg.: | 5000 |